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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor:	Wilk, et al.	Docket:	TI-24742
Appl. No.:	09/176,422	Examiner:	K. Nguyen
Filed:	10/21/98	Art Unit:	2823
Conf. No.	8175		
For:	Low Temperature Method for Forming a Thin, Uniform Oxide		

LETTER TO OFFICIAL DRAFTSPERSON UNDER 37 CFR 1.84

January 12, 2006

Mail Stop Issue Fee
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Washington, DC 22313-1450 on

January 18, 2006.

Tina Smith

Tina Smith

Draftsperson:

Applicants submit 2 sheets of formal drawings for the above-identified application. Please charge any necessary fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

Respectfully submitted,

David Denker
Reg. No. 40,987

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